

FIG. 1

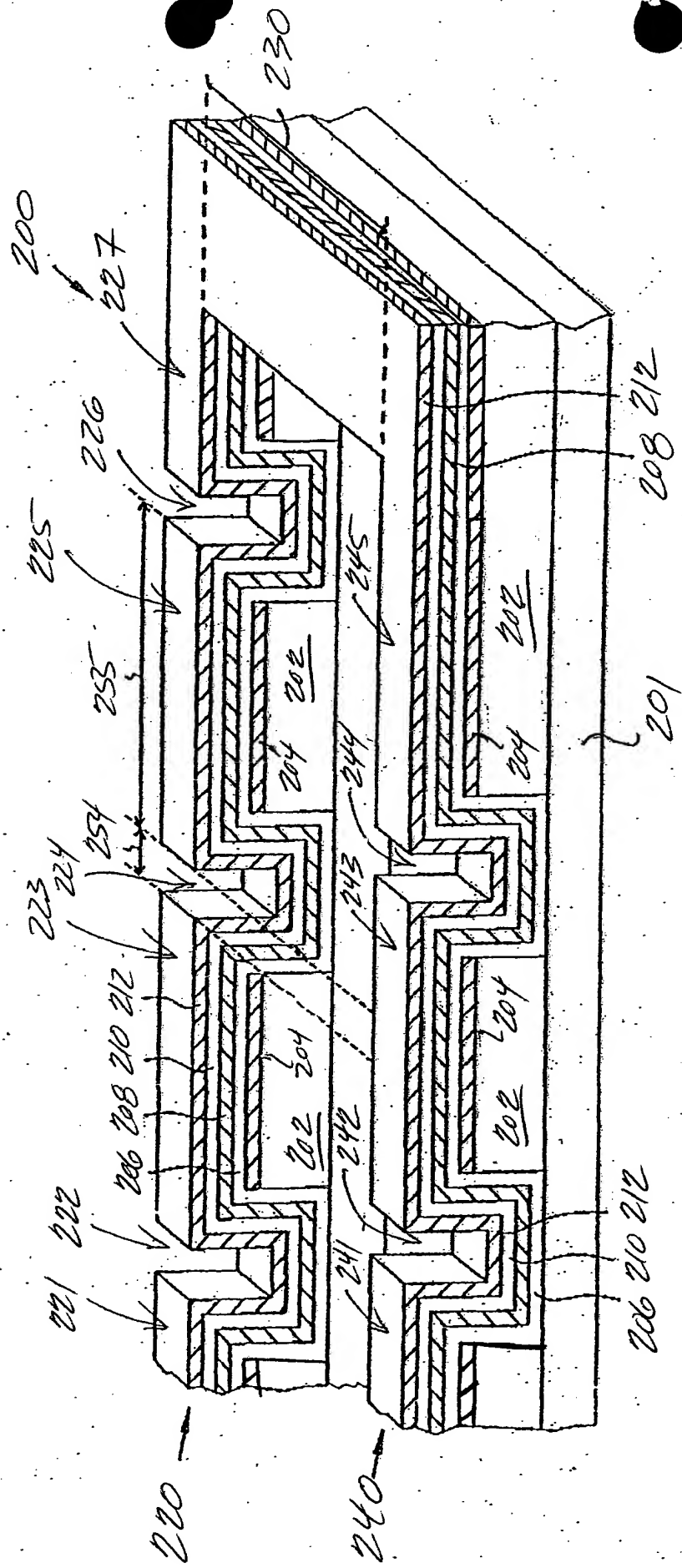


FIG. 2

Patented Oct. 10, 1967

300



310



360

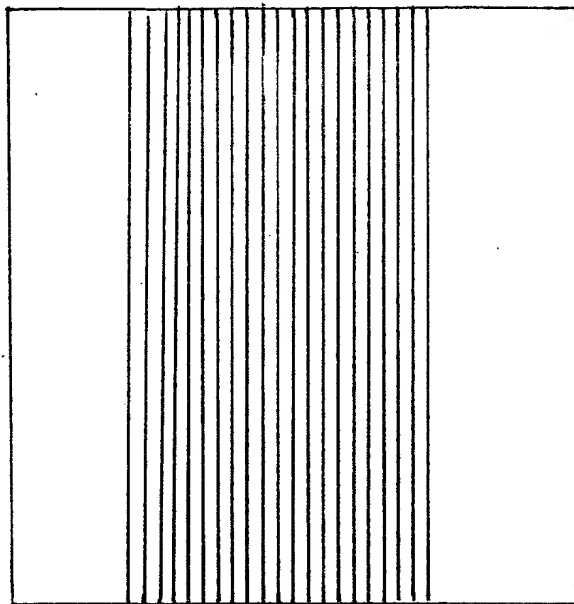
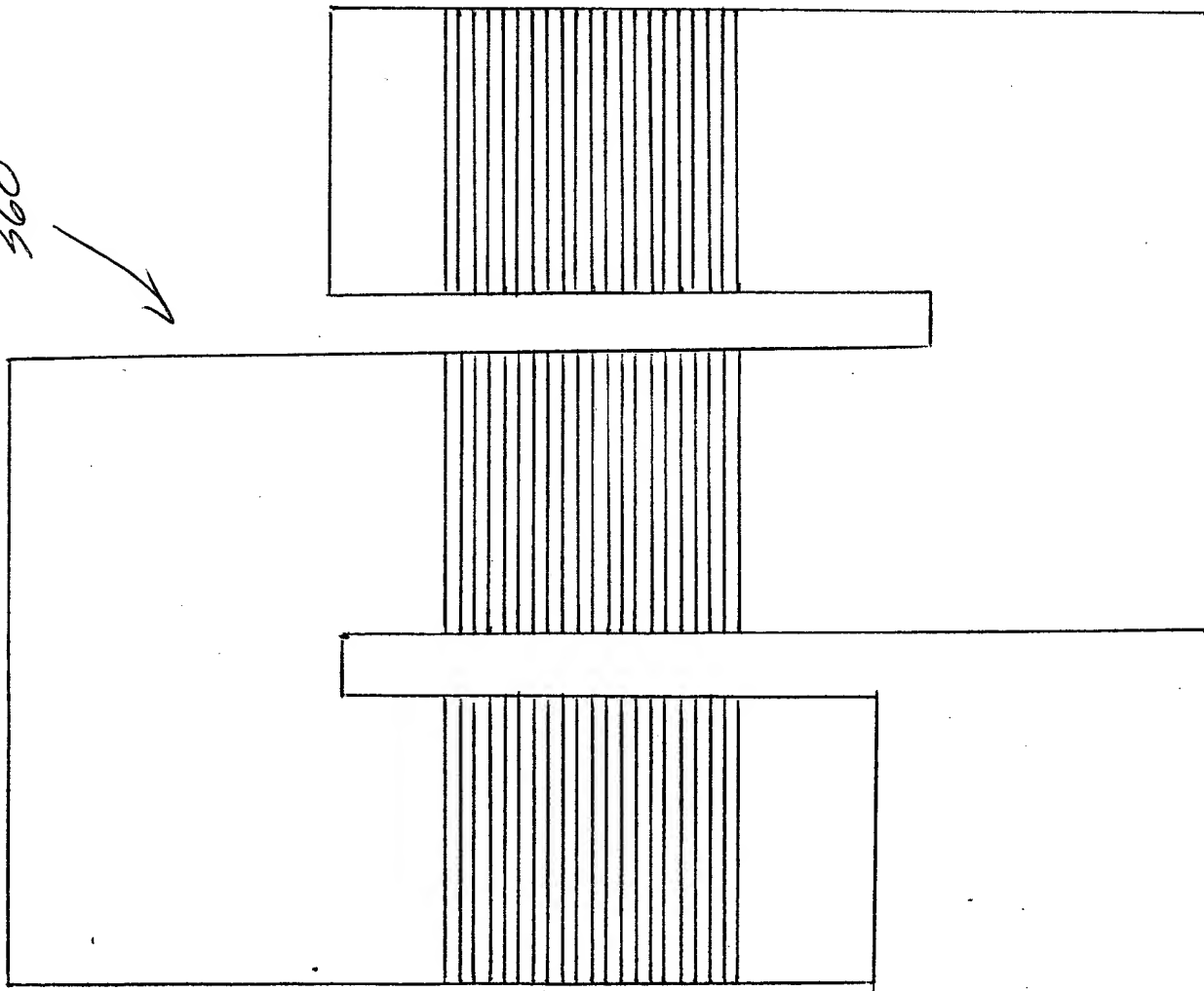
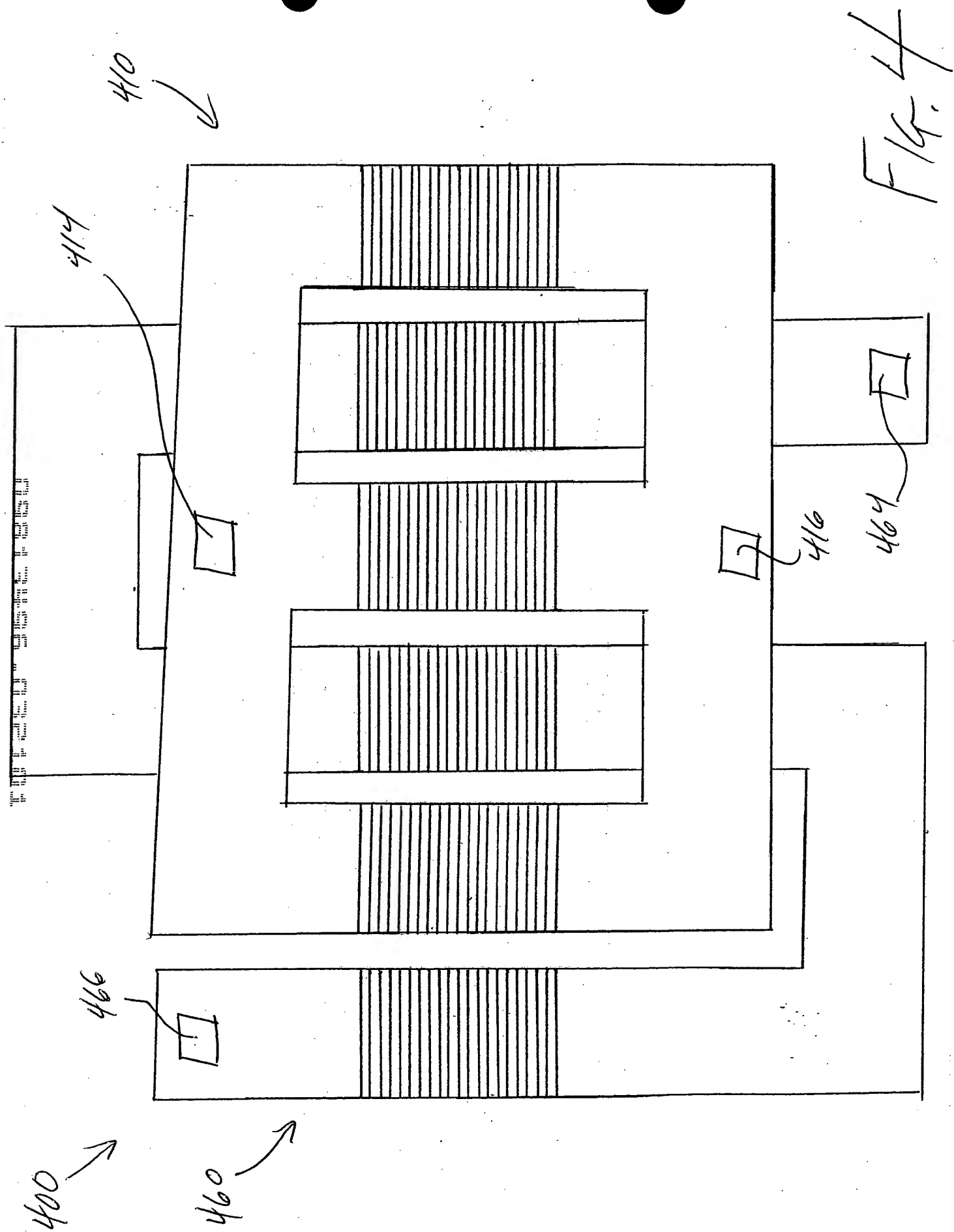


Fig. 3



500

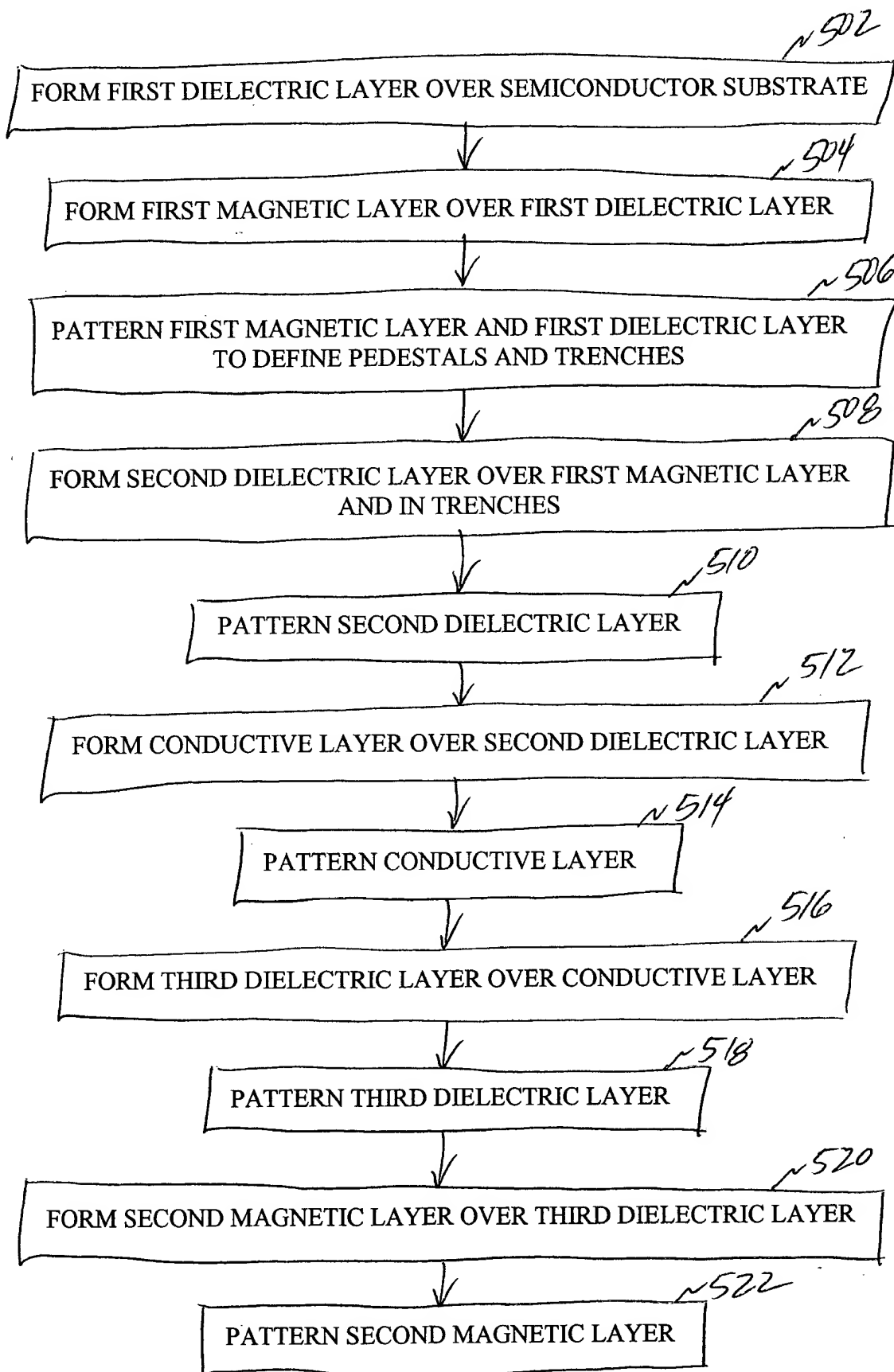


FIG. 5

### FORM UNDERLYING LAYER OVER DIELECTRIC LAYER

FORM MAGNETIC MATERIAL LAYER OVER UNDERLYING LAYER

FORM OVERLYING LAYER OVER MAGNETIC MATERIAL LAYER

### FORM PATTERNED MASK LAYER OVER OVERLYING LAYER

## ETCH UNDERLYING, MAGNETIC MATERIAL, AND OVERLYING LAYERS

**DECLARATION**

Fig. 6

FIG. 7

700

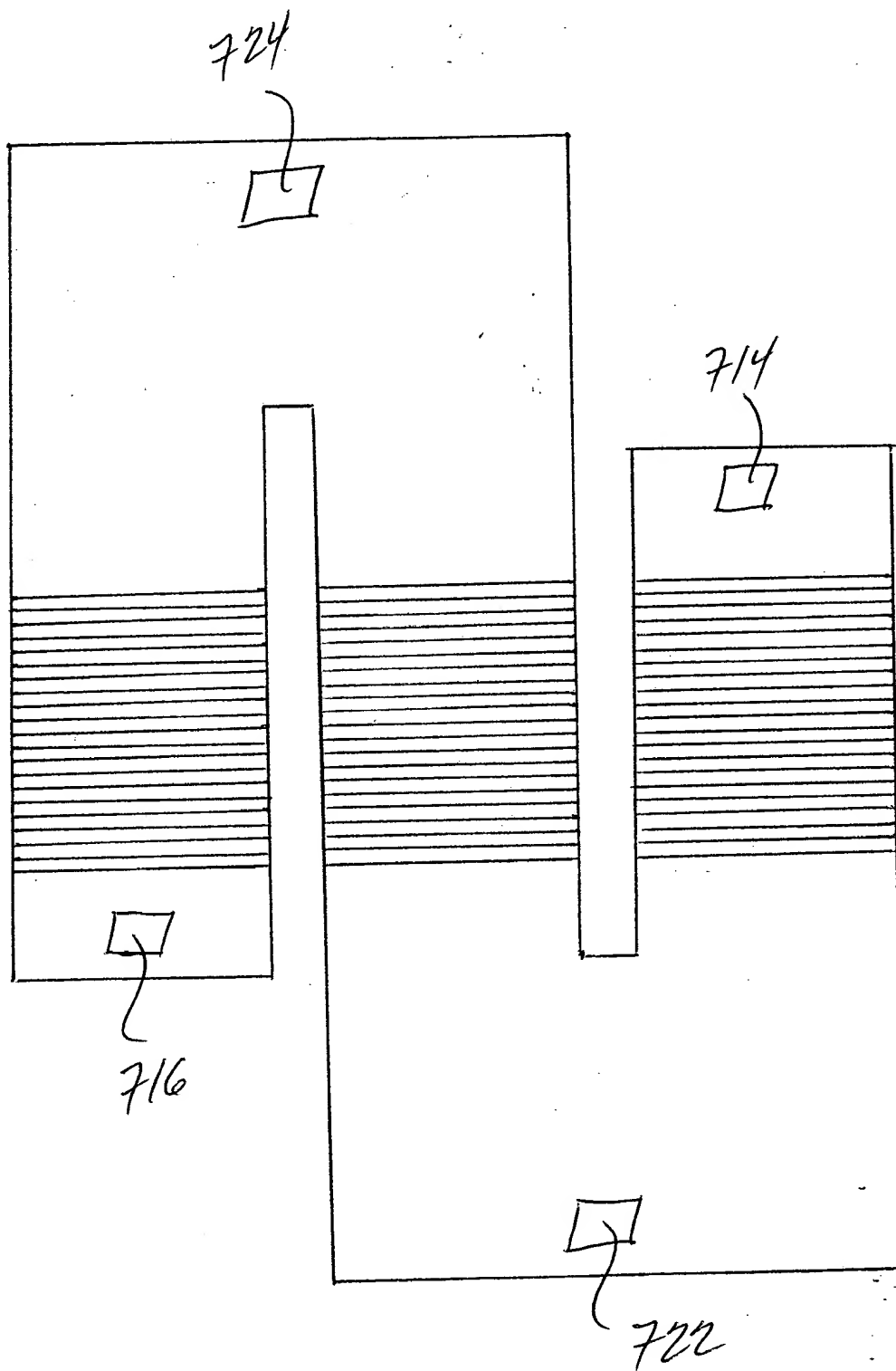


FIG. 7

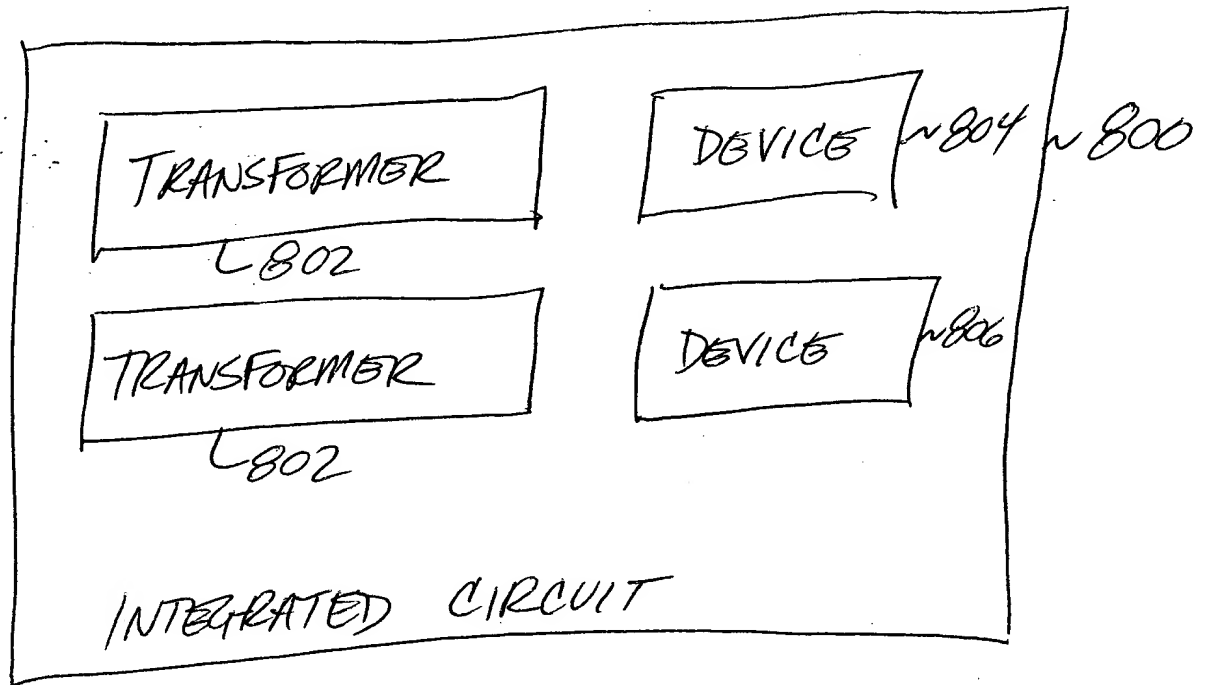


FIG. 8

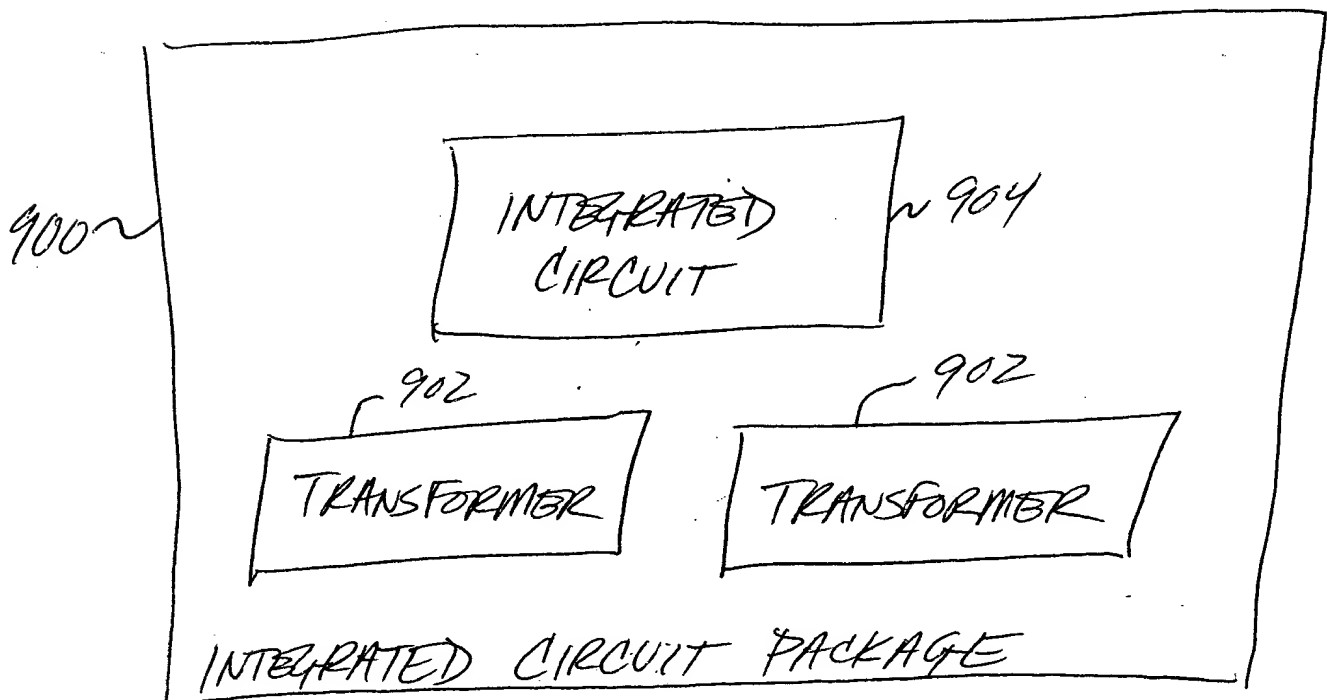


FIG. 9